

# **SPECIFICATION**

# 宏致電子股份有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Jhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808 FAX: +886-3-463-1800

SPEC. NO.:	PS-5023	36-xxxx	<b>REVISION:</b>	D
PRODUCT N	NAME:	1.00 mm Pitch SMT	Wire to Board Singal Row I	Housing
PRODUCT N	iO:	50236 · 87214-Wx	、71215 series	

PREPARED: CHECKED: APPROVED:

GAOLI XIUJIN XUZHIYONG

DATE: DATE: 2022.11.29

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# TITLE: 1.00 MM PITCH SMT WIRE TO BOARD DUAL ROW CONNECTOR

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# 1 Revision History

Rev.	ECN#	Revision Description	Approved	Date	
O	ECN- 0812210	New release	Jason	2008.11.25	
Α	ECN-1401184	ADD WORKING VOLTAGE	Xufei	2014.01.10	
В	ECN-1709396	ADD 3PIN Mating / Unmating Forces	CHENYA	2017.09.11	
С	ECN-1805282	ADD 7PIN Mating / Unmating Forces	ZHANG HAO	2017.09.11	
D	ECN-009798	ADD 9PIN Mating / Unmating Forces		2022 11 20	
D	ECN-009/98	ADD 71215 SERIES	Gaoli	2022.11.29	



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#### 2 SCOPE

This specification covers performance, tests and quality requirements for 1.00 mm Pitch SMT Wire to Board Housing.

P/N: 50236-XXXHXXX-XXX (Housing); 71215-XXXHXXX-XXX (Housing)

87214-Wx(Terminal)50224-XXXXX-XXX

#### 3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

# 4 REQUIREMENTS

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
  - 4.2 Materials and Finish
    - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: Pls see order information

**4.2.2** Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

- 4.3 Ratings
  - 4.3.1 Working voltage less than 36 volts (per pin)

4.3.2 Voltage: 50 Volts AC (per pin)

4.3.3 Current: AWG# 28 1A AC

AWG# 30 1A AC AWG# 32 1A AC

4.3.4 Operating Temperature : -25°C to +85°C



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# 5 Performance

# 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
	Product shall meet requirements of	
Examination of Product	applicable product drawing and	per applicable quality inspection
	specification.	plan.
	ELECTRICAL	
Item	Requirement	Standard
	55 m Ω Max.(initial)per contact	Mate connectors, measure by dry
Low-signal Level Contact Resistance	20 m Ω Max. Change allowed	circuit, 20mV Max., 10mA Max.
Contact Resistance		(EIA-364-23)
		Unmated connectors, apply
		500 V DC between adjacent
Insulation Resistance	100 M Ω Min.	terminals.
		(EIA-364-21)
	250 VAC Min. at sea level for 1	Test between adjacent contacts of
Diologtrio	minute.	unmated connectors.
Dielectric Withstanding Voltage	No discharge, flashover or	
Willistanding Voltage	breakdown.	(EIA-364-20)
	Current leakage: 1 mA max.	
		Mate connector: measure the
		temperature rise at rated current after:1 A/Power contact. The
		temperature rise above ambient
Temperature rise	30°C Max. Change allowed	shall not exceed 30°C The ambient
		condition is still air at 25℃
		(=14.004.=0.14==110=.0)
		(EIA-364-70 METHOD 2)
	MECHANICAL	
		The sample should be mounted in
1		the tester and fully mated and
Durahility	20 avalas	unmated the number of cycles
Durability	30 cycles.	specified at the rate of 25.4 ± 3mm/min.
		23.4 1 31111/111111.
		(EIA-364-09)
		Operation Speed :
		25.4 ± 3 mm/minute
Mating / Unmating Forces	Mating Force: See the table	Measure the force required to
	Unmating Force: See the table	mate/Unmate connector.
		(EIA-364-13)
	AVA/C# 20: 10NLN4INL	Fix the crimped terminal, apply axial
Crimping pull out Force	AWG# 28: 10N MIN AWG# 30: 5N MIN	pull out force on the wire at speed
Chimping pull out Force	AWG# 30: 3N MIN	rate 25.4 ± 3 mm/minute.
	7 WV Sir OZ. SIN WIIIN	



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Pin Retention force	3N MIN	apply axial pull out force on the wire at speed rate 25.4 ± 3 mm/minute.		
Terminal / Housing Retention Force	0.7kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.		
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)		
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)		
	ENVIRONMENTA			
Resistance to Reflow Soldering Heat		Pre Heat: 150°C ~180°C, 60~90sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max.		
Thermal Shock	See Product Qualification and Tes Sequence Group 4	Mate module and subject to follow condition for 5 cycles.		
Humidity	See Product Qualification and Tes Sequence Group 4	Mated Connector		
Temperature life	See Product Qualification and Tes Sequence Group 8	Subject mated connectors to		
Salt Spray	See Product Qualification and Tes			



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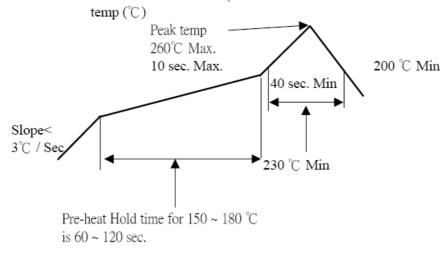
	Sequence Group 5	connectors to 5% salt-solution concentration, 35°C for 8 hours. (EIA-364-26,Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at $245 \pm 5^{\circ}$ C, for 4-5 sec. (EIA-364-52)
GWIT (FOR 71215)	Temperature set to 750°C (± 10°C)	No ignition of the test specimem or Visible flames extinguish within 5s (IEC 60695-2-13)
GWFI (FOR 71215)	Temperature set to 850°ℂ (± 10°ℂ )	No ignition of the test specimem or Flames or glowing extinguish within 30s No ignition of the after removal of the glow-wire No ignition of the tissue paper (IEC 60695-2-12)

Note. Flowing Mixed Gas shell be conduct by customer request.

## 6 INFRARED REFLOW CONDITION

#### 6.1. Lead-free Process

# TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE )



connectors

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# 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group											
Test or Examination	1	2	3	4	5	6	7	8	9	10	11	12
	Test Sequence											
Examination of Product				1 . 7	1 . 6	1 \ 4				1	1	1
Low-signal Level Contact Resistance		1 \ 5	1 \ 4	2 \ 10	2 . 9	2 ` 5				3		
Insulation Resistance				3、9	3 . 8							
Dielectric Withstanding Voltage				4 . 8	4 \ 7							
Temperature rise	1											
Mating / Unmating Forces		2 \ 4										
Durability		3										
Vibration			2									
Shock (Mechanical)			3									
Thermal Shock				5								
Humidity				6								
Temperature life					5							
Salt Spray						3						
Solder ability							1					
Crimping pull out Force								1				
Terminal / Housing Retention Force									1			
Resistance to Soldering Heat										2		
GWIT											2	
GWFI												2
Sample Size	2	4	4	4	4	4	2	4	4	4	5	5



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# 8 INSERTION & WITHDRAWAL FORCE( Mating / Unmating Forces)

Number of	At	At 30th		
Circuits	I.F.(max)	I.F.(max) W.F.(min)		
03	15	3	3	
07	20	5	5	
09	40	5	5	
20	50	5	5	
30	60	6	6	
40	70	7	7	
50	80	8	8	

單位:N

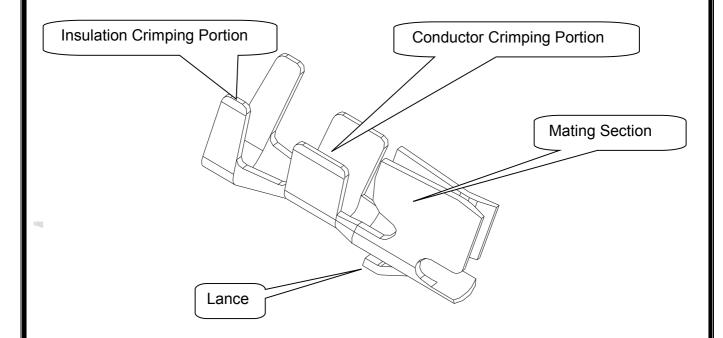
-10



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#### 9 ANATOMY OF CRIMPING TERMINAL



The crimping contact drawing is for reference only. May Not be the same with this P/N

# 10 APPLICABLE WIRES: UL3302 AND UL1571(AWG#34) ETFE WIRE

AWG Size:AWG#28 Insulation OD: Φ0.65mm AWG Size:AWG#30 Insulation OD: Φ0.70mm AWG Size:AWG#32 Insulation OD: Φ0.60mm



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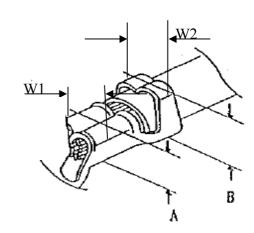
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## 11 CRIMPING CONDITION

	鉚線條件表 CRIMPING CONDITION									
Part Number Wire Specification Crimp Height (mm) Crimp Width (mm)										
	UL Style (REF.)	AWG Size	Insulation OD(mm)	Conductor A	Insulation B	Conductor W1	Insulation W2			
87214-W	UL3302	28	0.65	0.80Max	1.05~1.15	0.55~0.65	0.80Max			
87214-W	UL3302	30	0.70	0.75Max	1.10~1.20	0.50~0.60	0.80Max			
87214-W	UL3302	32	0.60	0.60Max	1.00~1.10	0.50~0.60	0.80Max			

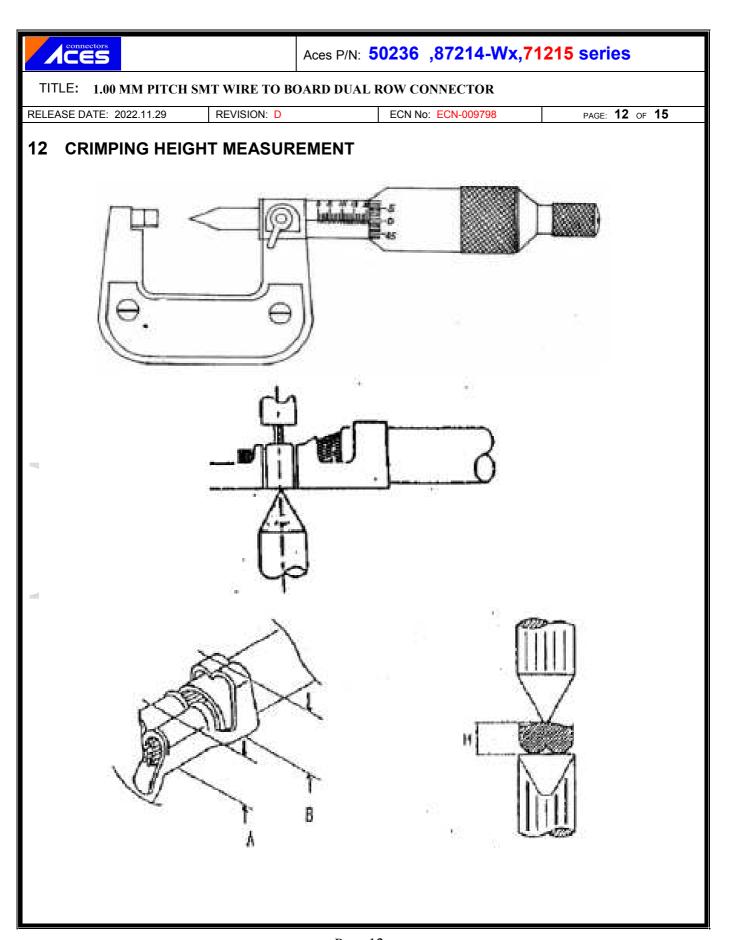






#### Note:

- 1、W1為芯線導體鉚壓後之寬度(Conductor Crimping Width):W1值如上表
- 2、W2為電線外被部分鉚壓後之寬度(Insulation Crimping Width): W2值如上表
- 3、A為芯線導體鉚壓後之高度(Conductor Crimping height): A值如上表(參考值)
- 4、B為電線外被鉚壓後之高度(Insulation Crimping height):B值如上表(參考值)
- 5、電線剝皮長度(Strip length): 1.3~1.6mm (參考值)

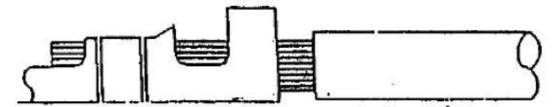




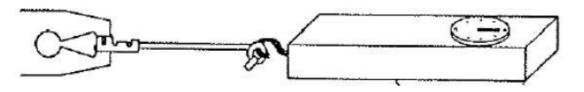
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# 13 PULL FORCE OF CRIMPING SECTION MEASUREMENT

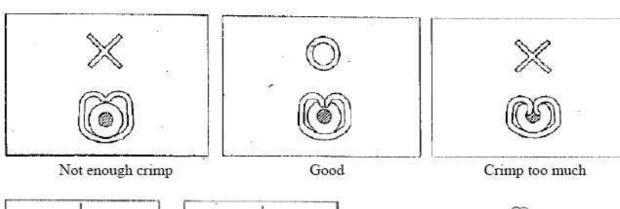


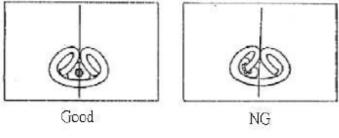
Before test samples, please measure crimp height and do not crimp insulation.



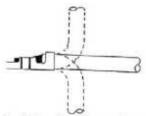
Pull Force of Crimp Section Measurement

## 14 STANDARD INSULATION CRIMPING

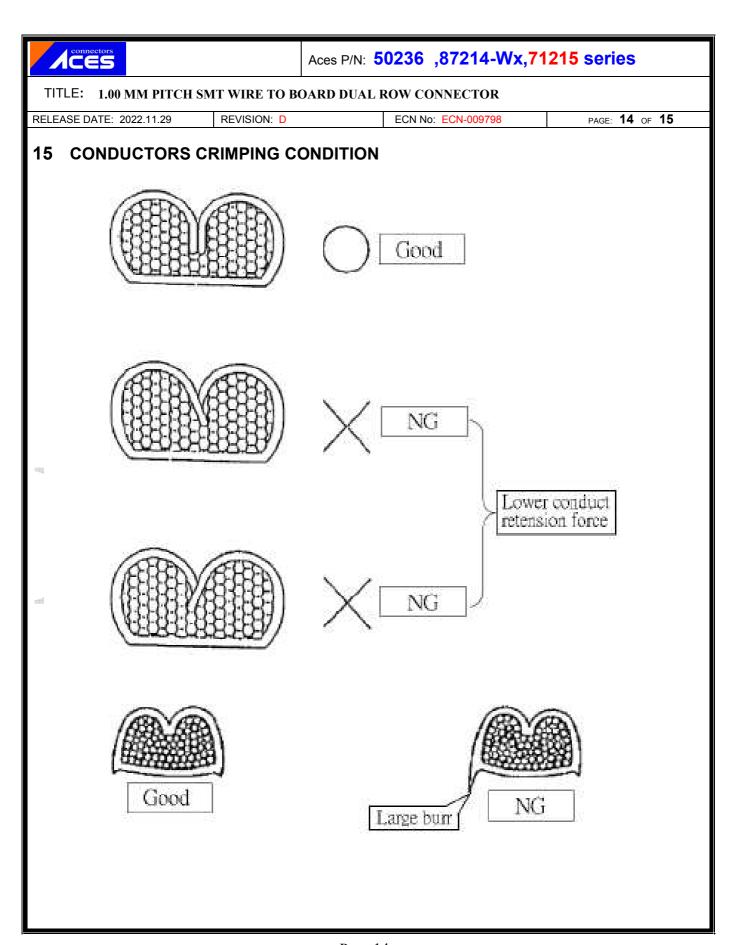




Insulation Crimp Condition



As following figure shown. It is no problem if wire bent up down 90 degrees 1 cycle and insulation position still in ideal position.

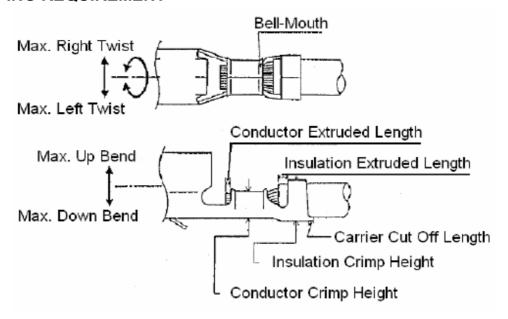




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# 16 CRIMPING REQUIREMENT



Item	Range(Ref.)
Max. Up Bend	6°
Max. Down Bend	6°
Max. Left Twist	5°
Max. Right Twist	5°
Bell-Mouth Length	0.1~0.3mm
Carrier Cut Off Length	0~0.2mm
Conductor Extruded Length	0.05~0.2mm